## PRODUCT CHANGE NOTICE

<table>
<thead>
<tr>
<th>PART NUMBER(S):</th>
<th>PCN No.: 06-0130-14a</th>
</tr>
</thead>
<tbody>
<tr>
<td>Please see attachment.</td>
<td>DATE: February 24, 2006</td>
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### PART DESCRIPTION:

Power Management and Interface Products – Change in Wafer Fabrication Site

### LEVEL OF CHANGE:

- [X] Level I, Customer Approval.
- [ ] Level II, Customer Information.

### PRODUCT ATTRIBUTE AFFECTED:

- [ ] Material Change
- [ ] Design Change
- [X] Process Change
- [ ] Packing / Shipping
  
  - [X] Other, Explain: Wafer Fabrication Site Transfer

### DESCRIPTION OF CHANGE:

Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry Silan. See attached Product List no. 14a.

### REASON FOR CHANGE:

Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.


* Samples representative of product from the Product Family being transferred.
# PRODUCT CHANGE NOTICE

**EARLIEST DATE OF PRODUCTION SHIPMENTS:** November 16, 2006

**EFFECTIVITY CHANGE DATE OR DATE CODE:** Work week associated with earliest production shipment.

<table>
<thead>
<tr>
<th>[ ]</th>
<th>STANDARD DISTRIBUTION</th>
<th>[ X ]</th>
<th>CUSTOM DISTRIBUTION</th>
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**PERSON TO CONTACT WITH QUESTIONS:**

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Sipex Corporation  
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FAX NUMBER: 408-935-7678
PCN No.: 06-0130-14a

List 14a

SP332CT
SP332CT-L
SP332ET
SP332ET-L
SP333CT
SP333CT-L
SP333ET
SP333ET-L
SP334CA
SP334CA-L
SP334CT
SP334CT-L
SP334ET
SP334ET-L